BLC9G15XS-400AVT

Power LDMOS transistor Rev. 1 — 24 November 2017

AMMPLEON

Product data sheet

Product profile 1.

1.1 General description

400 W LDMOS packaged asymmetric Doherty power transistor for base station applications at frequencies from 1452 MHz to 1511 MHz.

Typical performance

Typical RF performance at $T_{case} = 25$ °C in an asymmetrical Doherty production test circuit. V_{DS} = 32 V; I_{Dq} = 810 mA (main); $V_{GS(amp)peak}$ = 0.5 V, unless otherwise specified.

Test signal	f	V _{DS}	$P_{L(AV)}$	G_p	η _D	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
1-carrier W-CDMA	1452 to 1511	32	93	16	47.6	-34 <u>[1]</u>

^[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.6 dB at 0.01 % probability on

1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

RF power amplifiers for base stations and multi carrier applications in the 1452 MHz to 1511 MHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description		Simplified outline	Graphic symbol
1	drain2 (peak)			0.7
2	drain1 (main)		7 2 1 6	2, 7
3	gate1 (main)		5	
4	gate2 (peak)		3 4	3——5
5	source	[1]		4—
6	video decoupling (peak)			" ¬
7	video decoupling (main)			1, 6 aaa-014884

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BLC9G15XS-400AVT	-	air cavity plastic earless flanged package; 6 leads	SOT1258-4			

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V _{GS(amp)main}	main amplifier gate-source voltage		-6	+13	V
V _{GS(amp)peak}	peak amplifier gate-source voltage		-6	+13	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C
T _{case}	case temperature	operating [1]	-40	+125	°C

^[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-c)}	thermal resistance from junction to case	V _{DS} = 32 V; I _{Dq} = 980 mA (main); V _{GS(amp)peak} = 0,4 V; T _{case} = 80 °C		
		P _L = 93 W	0.28	k/W
		P _L = 117 W	0.26	k/W

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6. Characteristics

Table 6. DC characteristics

 T_i = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Main dev	vice					
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1.62 \text{ mA}$	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	V _{DS} = 10 V; I _D = 162 mA	1.5	2.0	2.5	V
V_{GSq}	gate-source quiescent voltage	V _{DS} = 32 V; I _D = 810 mA	1.65	2.15	2.65	V
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 32 V	-	-	2.8	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V$	-	32	-	Α
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 0 V	-	-	280	nΑ
9 _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 8.1 A	-	10.8	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 5.67 \text{ A}$	-	89	149	mΩ
Peak dev	/ice					
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 3.0 \text{ mA}$	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	V _{DS} = 20 V; I _D = 300 mA	1.5	2.0	2.5	V
V_{GSq}	gate-source quiescent voltage	V _{DS} = 32 V; I _D = 1500 mA	1.65	2.15	2.65	V
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 32 V	-	-	2.8	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V$	-	58	-	Α
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 0 V	-	-	280	nA
9 _{fs}	forward transconductance	V _{DS} = 20 V; I _D = 15 A	-	17.6	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 10.5 \text{ A}$	-	55	85	mΩ

Table 7. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH; f_1 = 1455 MHz; f_2 = 1508.5 MHz; RF performance at V_{DS} = 32 V; I_{Dq} = 810 mA (main); $V_{GS(amp)peak}$ = 0.5 V; T_{case} = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at frequencies from 1452 MHz to 1511 MHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P _{L(AV)} = 93 W	14.8	16	-	dB
RLin	input return loss	P _{L(AV)} = 93 W	-	-14	-10	dB
η_{D}	drain efficiency	P _{L(AV)} = 93 W	44	47.6	-	%
ACPR	adjacent channel power ratio	P _{L(AV)} = 93 W	-	-34	-29	dBc

Table 8. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH; f = 1508.5 MHz; RF performance at V_{DS} = 32 V; I_{Dq} = 810 mA (main); $V_{GS(amp)peak}$ = 0.5 V; T_{case} = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at a frequency of 1511 MHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PARO	output peak-to-average ratio	P _{L(AV)} = 110 W	6.1	6.7	-	dB
$P_{L(M)}$	peak output power	P _{L(AV)} = 110 W	439	510	-	W

7. Test information

7.1 Ruggedness in Doherty operation

The BLC9G15XS-400AVT is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 810 mA; $V_{GS(amp)peak}$ = 0.5 V; f = 1454.5 MHz; P_L = 126 W (5 dB OBO); 1-carrier W-CDMA; 100 % clipping.

7.2 Impedance information

Table 9. Typical impedance of main device

Measured load-pull data of main device; I_{Dq} = 810 mA (main); V_{DS} = 32 V; pulsed CW (t_p = 100 μ s; δ = 10 %).

f	Z _S [1]	Z _L [1]	P _L [2]	η _D [2]	G _p [2]					
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)					
Maximun	Maximum power load									
1440	1.0 - j4.0	1.3 – j3.0	306.3	66.3	17.1					
1480	1.5 – j3.9	1.3 – j3.4	292.8	64.2	17.0					
1510	1.3 – j4.3	1.4 – j3.2	296.7	66.4	17.4					
Maximun	n drain efficiency	load								
1440	1.0 - j4.0	2.9 – j3.1	202.0	72.2	19.5					
1480	1.5 – j3.9	2.2 - j3.0	237.3	72.3	18.7					
1510	1.3 – j4.3	2.6 – j2.8	203.3	72.1	19.5					

^[1] Z_S and Z_L defined in Figure 1.

Table 10. Typical impedance of peak device

Measured load-pull data of peak device; I_{Dq} = 1500 mA (peak); V_{DS} = 32 V; pulsed CW (t_p = 100 μ s; δ = 10 %).

f	Z _S [1]	Z _L [1]	P _L [2]	η _D [2]	G _p [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
Maximum	power load				
1440	1.6 – j6.3	2.0 – j2.9	458.2	60.6	17.1
1480	2.3 – j7.3	1.9 – j2.9	468.7	60.3	16.9
1510	2.5 – j7.9	1.8 – j2.7	471.8	59.9	17.1
Maximum	drain efficiency	load			
1440	1.6 – j6.3	3.9 – j2.2	335.8	66.6	18.9
1480	2.3 – j7.3	3.2 – j2.2	386.3	67.0	18.4
1510	2.5 – j7.9	3.1 – j1.5	347.9	67.3	19.1

^[1] Z_S and Z_L defined in <u>Figure 1</u>.

^[2] At 3 dB gain compression.

^[2] At 3 dB gain compression.

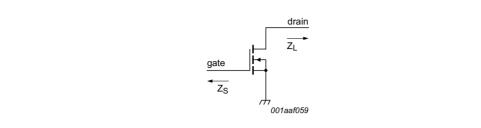


Fig 1. Definition of transistor impedance

7.3 Recommended impedances for Doherty design

Table 11. Typical impedance of main at 1:1 load

Measured load-pull data of main device; I_{Dq} = 810 mA (main); V_{DS} = 32 V; pulsed CW (t_p = 100 μ s; δ = 10 %).

f	Z _S [1]	Z _L [1]	P _{L(3dB)} [2]	η _D [3]	G _p [3]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
1440	1.0 – j4.0	1.5 – j3.4	283.8	42.2	20.6
1480	1.5 – j3.9	1.5 – j3.1	288.4	42.0	20.5
1510	1.3 – j4.3	1.5 – j2.9	284.4	42.2	20.7

- [1] Z_S and Z_L defined in Figure 1.
- [2] At 3 dB compression.
- [3] At $P_{L(AV)} = 93 \text{ W}$.

Table 12. Typical impedance of main device at 1: 2.5 load

Measured load-pull data of main device; I_{Dq} = 810 mA (main); V_{DS} = 32 V; pulsed CW (t_p = 100 μ s; δ = 10 %).

f	Z _S [1]	Z _L [1]	P _{L(3dB)} [2]	η _D [3]	G _p [3]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
1440	1.0 – j4.0	3.6 – j2.5	158.5	60.4	23.0
1480	1.5 – j3.9	3.6 – j2.4	156.0	61.2	23.0
1510	1.3 – j4.3	3.6 – j2.3	152.4	61.5	23.4

- [1] Z_S and Z_L defined in Figure 1.
- [2] At 3 dB compression.
- [3] At $P_{L(AV)} = 93 \text{ W}$.

Table 13. Typical impedance of peak device at 1:1 load

Measured load-pull data of peak device; I_{Dq} = 1500 mA (peak); V_{DS} = 32 V; pulsed CW (t_p = 100 μ s; δ = 10 %).

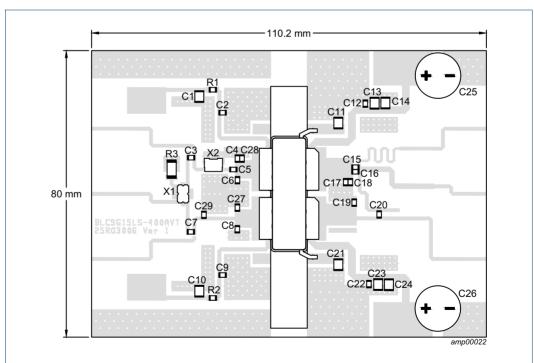
f	Z _S [1]	Z _L [1]	P _{L(3dB)} [2]	η _D [3]	G _p [3]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
1440	1.6 – j6.3	2.2 – j3.1	443.6	30.4	20.3
1480	2.3 – j7.3	2.2 – j2.7	451.9	30.9	20.5
1510	2.5 – j7.9	2.2 – j2.4	445.7	31.9	20.9

- [1] Z_S and Z_L defined in Figure 1.
- [2] At 3 dB compression.
- [3] At $P_{L(AV)} = 93 \text{ W}$.

Table 14. Off-state impedances of peak device

f	Z _{off}
(MHz)	(Ω)
1440	1.4 – j4.3
1480	0.7 – j2.7
1510	0.5 – j1.9

7.4 Test circuit



Printed-Circuit Board (PCB): Rogers 3006: ϵ_r = 6.15; thickness = 0.635 mm; thickness copper plating = 35 μ m. See Table 15 for a list of components.

Fig 2. Component layout

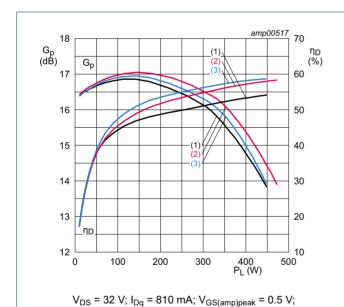
Table 15. List of components

See Figure 2 for component layout.

Component	Description	Value	Remarks
C1, C10, C11, C13, C14, C21, C23, C24	multilayer ceramic chip capacitor	4.7 μF	Murata GRM32ER71H475KA88L
C2, C3, C5, C7, C9, C12, C15, C16, C20, C22	multilayer ceramic chip capacitor	18 pF	Murata Hi-Q 0805
C4,C6, C27, C28	multilayer ceramic chip capacitor	2.0 pF	Murata Hi-Q 0805
C8,C17, C18	multilayer ceramic chip capacitor	1.8 pF	Murata Hi-Q 0805
C19	multilayer ceramic chip capacitor	2.7 pF	Murata Hi-Q 0805
C25, C26	electrolytic capacitor	470 μF	63 V
C29	multilayer ceramic chip capacitor	0.3 pF	ATC 100A 0805
R1, R2	SMD resistor	4.7 Ω, 1 %	0805
R3	SMD resistor	50 Ω, 25 W	Anaren C16A50Z4
X1	hybrid coupler	2 dB, 90°	Anaren X3C20F1-02S
X2	attenuator	1 dB	Anaren D10AAXXZ4

7.5 Graphical data

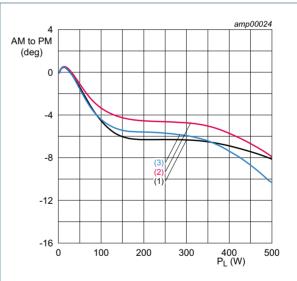
7.5.1 Pulsed CW



 $t_p = 100 \text{ µs}; \delta = 10 \text{ %}.$

- (1) f = 1452 MHz
- (2) f = 1492 MHz
- (3) f = 1511 MHz

Fig 3. Power gain and drain efficiency as function of output power; typical values



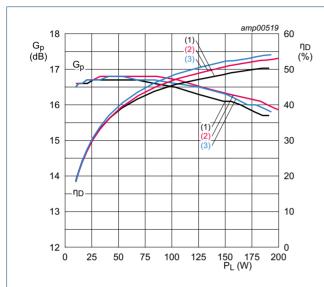
 V_{DS} = 32 V; I_{Dq} = 810 mA; $V_{GS(amp)peak}$ = 0.5 V.

- (1) f = 1452 MHz
- (2) f = 1492 MHz
- (3) f = 1511 MHz

Fig 4. AM to PM as a function of output power; typical values

7.5.2 1-Carrier W-CDMA

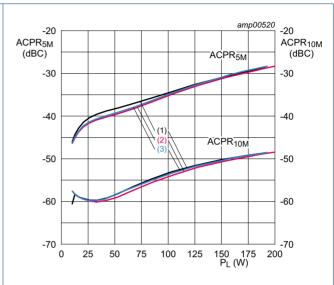
PAR = 9.6 dB per carrier at 0.01 % probability on the CCDF; 3GPP test model 1 with 64 DPCH (100 % clipping).



 V_{DS} = 32 V; I_{Dq} = 810 mA; $V_{GS(amp)peak}$ = 0.5 V.

- (1) f = 1454.5 MHz
- (2) f = 1489.5 MHz
- (3) f = 1508.5 MHz

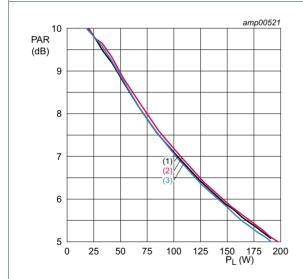
Fig 5. Power gain and drain efficiency as function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 810 \text{ mA}; V_{GS(amp)peak} = 0.5 \text{ V}.$

- (1) f = 1454.5 MHz
- (2) f = 1489.5 MHz
- (3) f = 1508.5 MHz

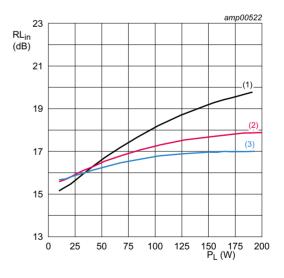
Fig 6. Adjacent channel power ratio (5 MHz) and adjacent channel power ratio (10 MHz) as function of output power; typical values



 V_{DS} = 32 V; I_{Dq} = 810 mA; $V_{GS(amp)peak}$ = 0.5 V.

- (1) f = 1454.5 MHz
- (2) f = 1489.5 MHz
- (3) f = 1508.5 MHz

Fig 7. Peak-to-average power ratio as a function of output power; typical values



 V_{DS} = 32 V; I_{Dq} = 810 mA; $V_{GS(amp)peak}$ = 0.5 V.

- (1) f = 1454.5 MHz
- (2) f = 1489.5 MHz
- (3) f = 1508.5 MHz

Fig 8. Input return loss as a function of output power; typical values

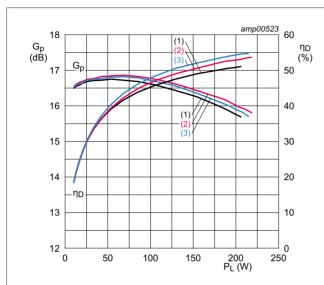
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7.5.3 2-Carrier W-CDMA

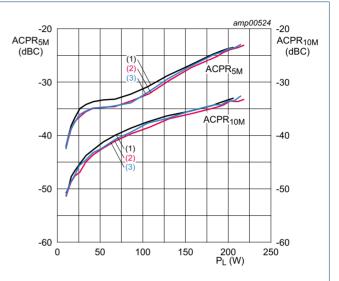
PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1 with 64 DPCH (46 % clipping).



 V_{DS} = 32 V; I_{Dq} = 810 mA; $V_{GS(amp)peak}$ = 0.5 V.

- (1) f = 1457 MHz
- (2) f = 1487 MHz
- (3) f = 1506 MHz

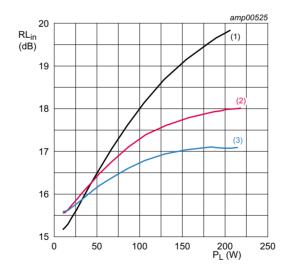
Fig 9. Power gain and drain efficiency as function of output power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 810 \text{ mA}; V_{GS(amp)peak} = 0.5 \text{ V}.$

- (1) f = 1457 MHz
- (2) f = 1487 MHz
- (3) f = 1506 MHz

Fig 10. Adjacent channel power ratio (5 MHz) and adjacent channel power ratio (10 MHz) as function of output power; typical values



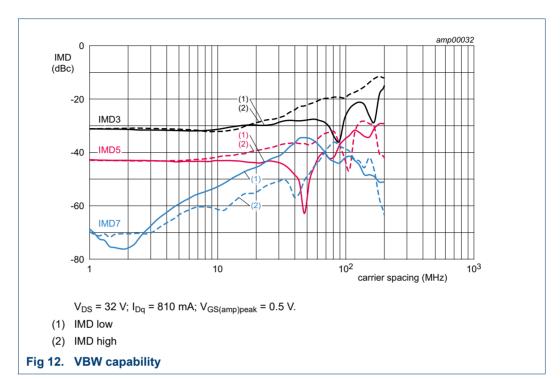
 $V_{DS} = 32 \text{ V}; I_{Dq} = 810 \text{ mA}; V_{GS(amp)peak} = 0.5 \text{ V}.$

- (1) f = 1457 MHz
- (2) f = 1487 MHz
- (3) f = 1506 MHz

Fig 11. Input return loss as a function of output power; typical values

BLC9G15XS-400AVT

7.5.4 2-Tone VBW



8. Package outline

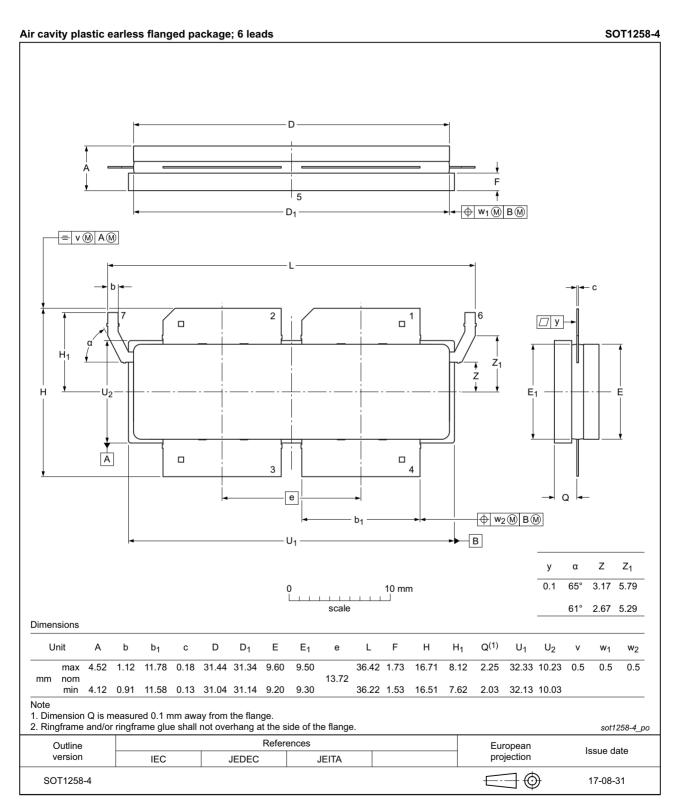


Fig 13. Package outline SOT1258-4

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 16. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	2 [2]

^[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V, but fails after exposure to an ESD pulse of 750 V.

10. Abbreviations

Table 17. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
AM	Amplitude Modulation
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
ОВО	Output Back Off
PAR	Peak-to-Average Ratio
PM	Phase Modulation
SMD	Surface Mounted Device
VBW	Video Bandwidth
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

11. Revision history

Table 18. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLC9G15XS-400AVT v.1	20171124	Product data sheet	-	-

^[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V, but fails after exposure to an ESD pulse of 4000 V.

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

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13. Contact information

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Power LDMOS transistor

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